Record Nr. UNINA9910144005303321 Adhesion [[electronic resource]]: current research and applications // **Titolo** edited by Wulff Possart Pubbl/distr/stampa Weinheim,: Wiley-VCH, c2005 **ISBN** 1-280-85418-9 9786610854189 3-527-60730-7 3-527-60710-2 Descrizione fisica 1 online resource (609 p.) Altri autori (Persone) **PossartWulff** Disciplina 541.33 620.199 Soggetti Adhesion Adsorption Lingua di pubblicazione Inglese **Formato** Materiale a stampa Livello bibliografico Monografia "Based on lectures held at the 7th European Conference on Adhesion"--Note generali P. vi. Includes bibliographical references and index. Nota di bibliografia Nota di contenuto Adhesion; Preface; Contents; List of Contributors; 1 The Interfacial Chemistry of Adhesion: Novel Routes to the Holy Grail?; Abstract; 1.1 Introduction; 1.2 Development of a Model Interphase; 1.3 The Buried Interface: 1.4 Conclusion: Acknowledgments: References: 2 Modeling Fundamental Aspects of the Surface Chemistry of Oxides and their Interactions with Coupling Agents; Abstract; 2.1 Introduction: Atomistic Simulations in Adhesion; 2.2 Prediction of Surface Properties: Ideal Reconstructions on -SiO(2) (0001); 2.3 Organic Components of the Adhesive and Substrate-Adhesive Interaction 2.4 Conclusion and OutlookReferences: 3 Adhesion at the Nanoscale: an Approach by AFM; Abstract; 3.1 Introduction; 3.2 Materials and Methods; 3.2.1 Preparation of Oxidized Silica Surface; 3.2.2 Grafting of Functionalized SAMs onto Silicon Wafer; 3.2.3 Crosslinking and Functionalization of PDMS Networks; 3.2.4 Characterization of the SAMs; 3.3 Results and Discussion; 3.3.1 Force-Distance Curve

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7 Properties of the Interphase Epoxy-Amine/Metal: Influences from the Nature of the Amine and the Metal

## Sommario/riassunto

Emphasizing the most recent developments this book addresses both the basic and applied aspects of adhesion. The authors present the latest results on fundamental aspects, adhesion in biology, chemistry for adhesive formulation, surface chemistry and the pretreatment of adherends, mechanical issues, non-destructive testing and the durability of adhesive joints, as well as advanced technical applications of adhesive joints. Prominent scientists review the current level of knowledge concerning the role of chemical bonds in adhesion, new resins and nanocomposites for adhesives, and about the role